2SK435

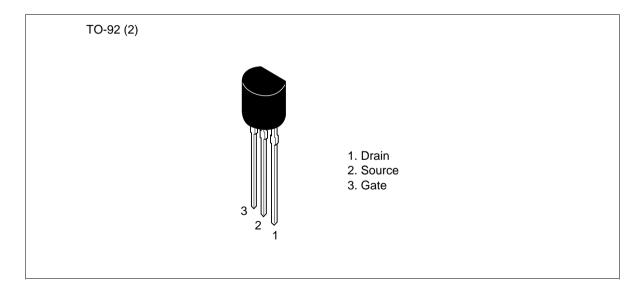
Silicon N-Channel Junction FET

HITACHI

Application

Low frequency / High frequency amplifier

Outline





2SK435

Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

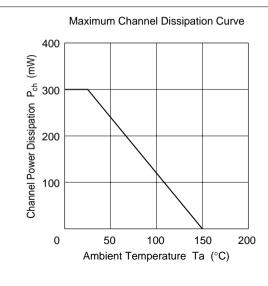
| Item | Symbol | Ratings | Unit |
|---------------------------|----------------|-------------|------|
| Drain to source voltage | V_{DS} | 22 | V |
| Gate to source voltage | $V_{\sf GSO}$ | -22 | V |
| Drain current | I _D | 100 | mA |
| Gate current | I _G | 10 | mA |
| Channel power dissipation | Pch | 300 | mW |
| Channel temperature | Tch | 150 | °C |
| Storage temperature | Tstg | -55 to +150 | °C |

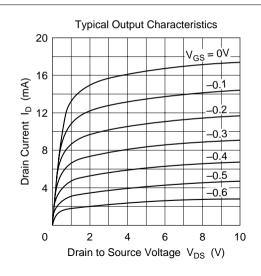
Electrical Characteristics (Ta = 25°C)

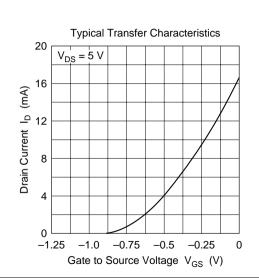
| Item | Symbol | Min | Тур | Max | Unit | Test conditions |
|----------------------------------|----------------------|-----|-----|------|------|--|
| Gate to source breakdown voltage | $V_{(BR)GSS}$ | -22 | _ | _ | V | $I_G = -10 \ \mu A, \ V_{DS} = 0$ |
| Gate cutoff current | I _{GSS} | _ | _ | -10 | nA | $V_{GS} = -15 \text{ V}, V_{DS} = 0$ |
| Gate to source cutoff voltage | $V_{\text{GS(off)}}$ | _ | _ | -2.5 | V | $V_{DS} = 5 \text{ V}, I_{D} = 10 \mu\text{A}$ |
| Drain current | l _{DSS} *1 | 6 | _ | 40 | mA | $V_{DS} = 5 \text{ V}, V_{GS} = 0, \text{ Pulse test}$ |
| Forward transfer admittance | y _{fs} | 20 | _ | _ | mS | $V_{DS} = 5 \text{ V}, I_{D} = 10 \text{ mA},$ f = 1kHz |
| Input capacitance | Ciss | _ | 9.0 | 11.0 | pF | $V_{DS} = 5 \text{ V}, V_{GS} = 0,$ f = 1MHz |
| Reverse transfer capacitance | Crss | _ | 2.8 | 4.0 | pF | $V_{DS} = 5 \text{ V}, V_{GS} = 0,$ f = 1MHz |
| Noise figure | NF | _ | 0.5 | 3.0 | dB | $V_{DS} = 5 \text{ V}, I_{D} = 1 \text{ mA},$ $f = 1 \text{kHz}, Rg = 1 \text{k}\Omega$ |

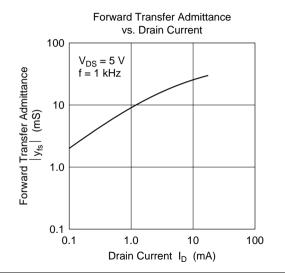
Note: 1. The 2SK435 is grouped by I_{DSS} as follows.

| Grade | В | С | D | E |
|------------------|---------|----------|----------|----------|
| I _{DSS} | 6 to 14 | 12 to 22 | 18 to 30 | 26 to 40 |

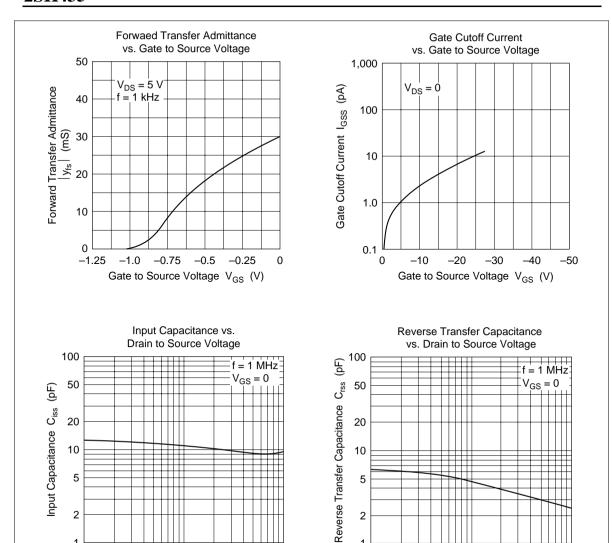








2SK435



2

1

0.1

0.2

0.5

2

5

10

1.0

Drain to Source Voltage V_{DS} (V)

2

1

0.1

0.2

0.5

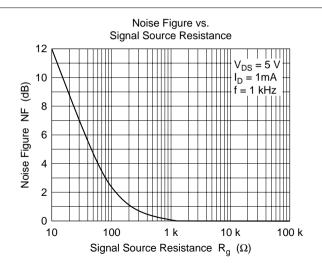
2

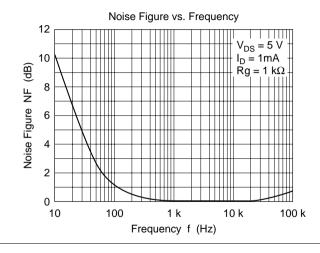
5

10

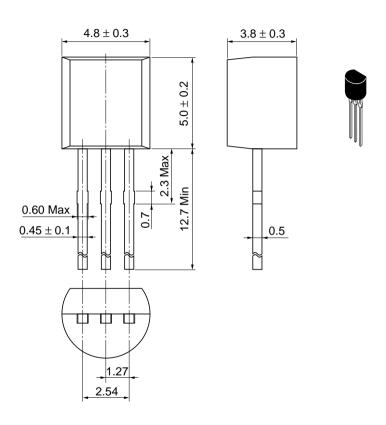
1.0

Drain to Source Voltage V_{DS} (V)





Unit: mm



| Hitachi Code | TO-92 (2) |
|--------------------------|-----------|
| JEDEC | Conforms |
| EIAJ | Conforms |
| Weight (reference value) | 0.25 g |

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HTACHI

Hitachi, Ltd.

Semiconductor & Integrated Circuits.

Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

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For further information write to:

Hitachi Semiconductor (America) Inc. 179 East Tasman Drive, San Jose,CA 95134 Tel: <1> (408) 433-1990 Fax: <1>(408) 433-0223 Hitachi Europe GmbH Electronic components Group Dornacher Stra§e 3 D-85622 Feldkirchen, Munich Germany Tel: <49> (89) 9 9180-0

Fax: <49> (89) 9 29 30 00 Hitachi Europe Ltd. Electronic Components Group. Whitebrook Park Lower Cookham Road Maidenhead Berkshire SL6 8YA, United Kingdom

Tel: <44> (1628) 585000 Fax: <44> (1628) 778322 Hitachi Asia Pte. Ltd. 16 Collyer Quay #20-00 Hitachi Tower Singapore 049318 Tel: 535-2100 Fax: 535-1533

Hitachi Asia Ltd. Taipei Branch Office 3F, Hung Kuo Building. No.167, Tun-Hwa North Road, Taipei (105) Tel: <886> (2) 2718-3666 Fax: <886> (2) 2718-8180

Hitachi Asia (Hong Kong) Ltd. Group III (Electronic Components) 7/F., North Tower, World Finance Centre, Harbour City, Canton Road, Tsim Sha Tsui, Kowloon, Hong Kong Tel: <852> (2) 735 9218

Fax: <852> (2) 730 0281 Telex: 40815 HITEC HX

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